



US Module Testing Update

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(On behalf of the US testing group)

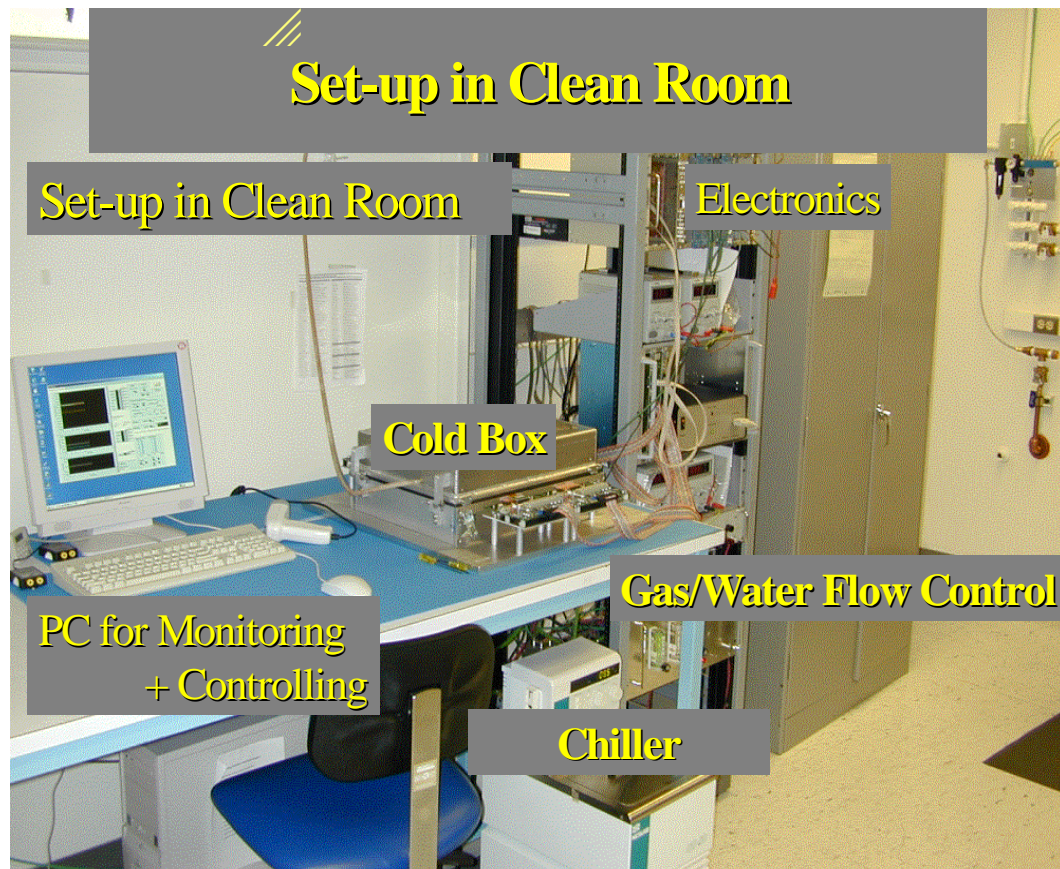
Update of Readiness

Description of Production

New Studies of CMN Modules



Hybrid Wire Bonding/Thermal Cycler



•80 hybrids bonded and thermal cycled

- 4 PLL failures at -20 C
- 2 APV failures
- Opens
 - 2 hybrids with 1 open
 - 3 hybrids with 2 opens
 - 1 hybrid with 3 opens
 - 1 hybrid with 4 opens
 - Opens due to AL pulling off PA

•UCSB thermal cycler fully commissioned

•FNAL thermal cycler built and being shipped

•Beginning to assemble test stand for Mexico City

Soon will have capability of ~80 hybrid thermal cycles per day



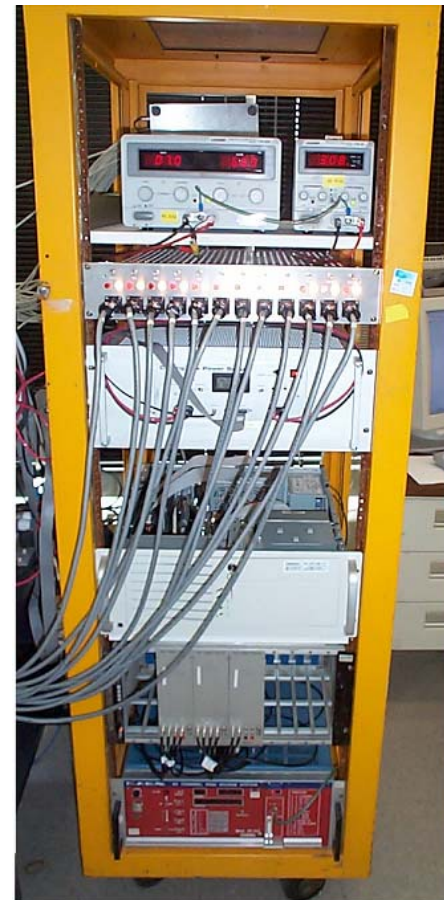
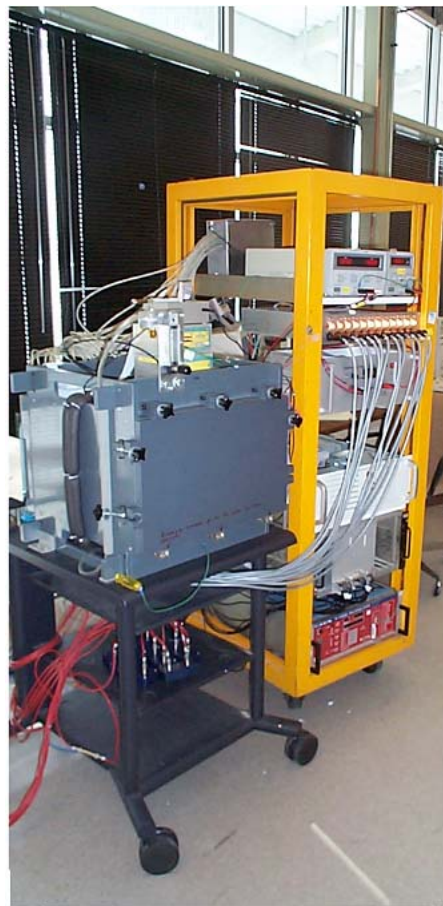
FNAL Vienna Box

- Fully Operational

- Installed F-MUX, TPO, NIM2LVDS, electrometers
- Calibrated electrometers readout

- Ready to thermo-cycle 10 modules at one time, ready to run 10-14 hours scenario with 3 thermal cycles, PedRun, CalRun, IVRun.

- Multiple people are trained to operate Lt stand (2 grad. students, 2 technicians)





UCSB 150 Module Production

- Goals

- To establish new peak production capacity (15 modules/day)
 - Determine if testing capabilities sufficient
- Build as many modules as possible using new ST sensors as agreed upon in December
 - Use sensor grading scheme to find out if subclass of perfect sensors exists

- Results

- Easily met testing capacity needs
- Extremely low rate of introduced failures seen
- CMN modules occurred at same rates as previous builds using re-probed sensors
 - Did not appear to depend on production period or sensor grading



New UCSB Production

- Expected peak production rate of 15 modules/day maintained over a two week period (150 modules)
 - Modules used sensor grading scheme by Vienna (A+,A,B)
- Complete set of module tests made
 - ARCS quick test
 - Module thermal cycle (Vienna Box)
 - 1 thermal cycle for each module (~7 hours)
 - After thermal cycle LED tests
- From this exercise, it is clear that we will be able to test the 15 module/day peak rate





UCSB Module Quality/Grading

- 117 modules tested so far
- Failure rates/sources (excluding CMN modules)
 - 0.39% Bad channels on average
 - 0.26% Known bad sensor channels
 - 0.13% Unmarked bad sensor channels
 - 0.004% open hybrid-APV bonds
 - 0.001% module bonding
 - 0.002% testing errors
 - Less than 0.01% bad channels introduced during assembly/bonding/testing

• Module Grading

- 103 Grade A
 - All due to sensor faults
- 5 Grade B
 - All due to sensor faults
- 7 Grade A/F
 - 6 CMN modules
 - 1 after thermal cycle
 - 1 module fails to operate at -20 C
 - Tested in 3 different Vienna box slots
- 2 Grade C/F
 - 12 mid-sensor opens in aluminum strips (lithographic errors)
 - 1 CMN module



UCSB Thermal Cycling Results

- 101 modules thermal cycled
 - One module does not function at -20 C
 - Tested in 3 different cold box slots
 - Hybrid bonded and thermal-cycled at UCSB without seeing this effect
 - One module developed CMN
 - Prior to thermal cycling, the channel had 10 ADC noise
 - Now consistently has CMN
 - One module have a single APV channel burn-out
 - Multiple noisy channels (2-5 ADC) appeared and disappeared after cycling



CMN modules and sensor grading

Sensor Grade	2001-2			2002-3			2003		
	NUMBER	CMN	%	NUMBER	CMN	%	NUMBER	CMN	%
GRADE A+	29	1	3.4%	4	1	25.0%	12	0	0.0%
GRADE A	38	2	5.3%	11	1	9.1%	16	1	6.3%
GRADE B	0	0	0.0%	6	1	16.6%	1	0	0.0%

- Sensors graded using Vienna rules

- All sensors were re-probed prior to assembly
- Worst sensor grading out of two measurements used

- Sensors sub-divided into three time periods

- 2001-2
 - Prior to Week 39, 2002 (Pre-production)
- 2002-3
 - Week 39, 2002-Week 12, 2003 (Production improvements being implemented)
- 2003
 - Week 13, 2003-now (Final Production)

- 7 Common mode modules found (6% of production)

- Same rate as seen previously with re-probed sensors
- 1 after thermal cycling

- No statistically significant difference rate in CMN modules for the different sensor grading



FNAL module testing summary

- 7 modules are produced in December-January
- Sensors were selected to have current below $1.5 \mu\text{m}$

	Module	709	710	711	712	713	714	715
sensors	# of bad channels	5 (72,74,82, 511,512)	0	1 (333)	1 (232 - lstrip)	2 (143) (201 – lstrip)	1 (202)	1 (281 - lstrip)
Module Information	Current (μA)	4.0	4.0	3.6	3.6	3.5	3.2	3.5
	# of bad channels	5 (72,74,82, 511,512)	0	1 (333)	0	2 (143, 486)	1 (202)	0
Grade		A	A	A	A	A	A	A
After Long term		ok	ok	278 (noisy)	ok	ok	ok	ok
Additional information				PH (#512) repaired	PH (#512) repaired	Metallizat ion problem Pinhole #486 pulled		

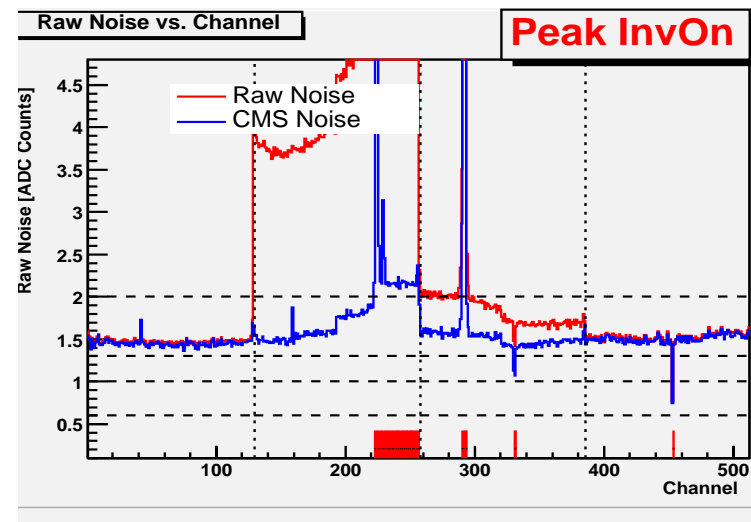
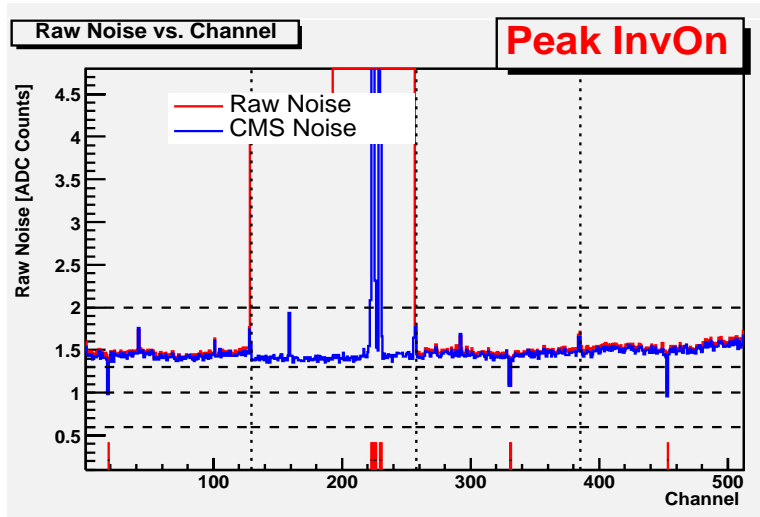


FNAL Retesting of CMN Modules

- 5 CMN modules still at FNAL studied further
 - Standardization of CMN module measurements
 - Turn-on point, determination of bad sensors, etc.
 - Serves as a measure of the stability of CMN modules
- Results
 - 2 of the 5 modules had degraded even further
 - Addition pinhole and additional CMN chip found
 - Turn-on of CMN effects occur near depletion voltage



Module Time Degradation- Module 689

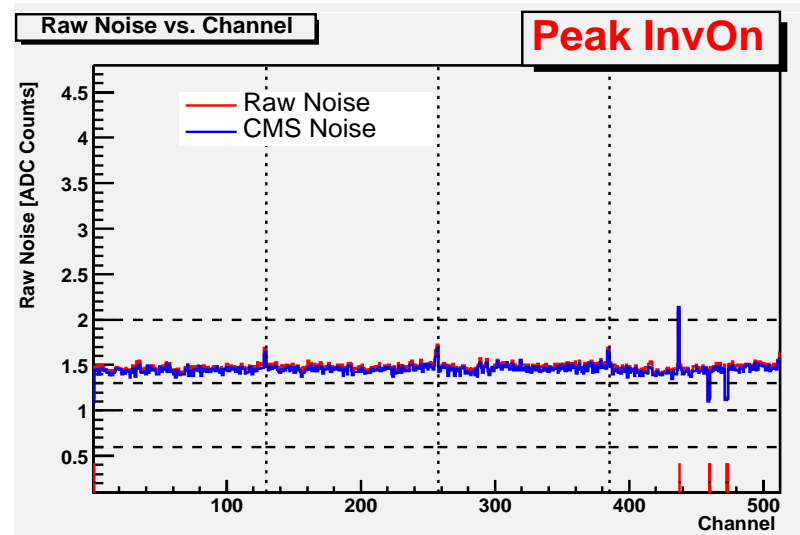


- After 3 months on shelf, module retested
- Second chip now has a high noise channel which causes common mode noise
 - Channel previously only had a slightly higher noise

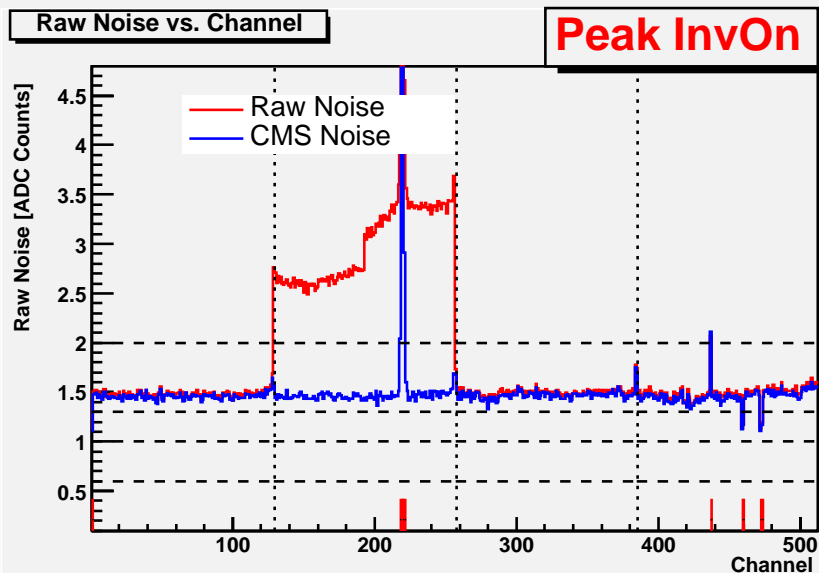


Module Time Degradation-705

- After assembly module was tested (09/08) on ARCS at 400 V and graded “B” (6 faulty channels). No problems observed.

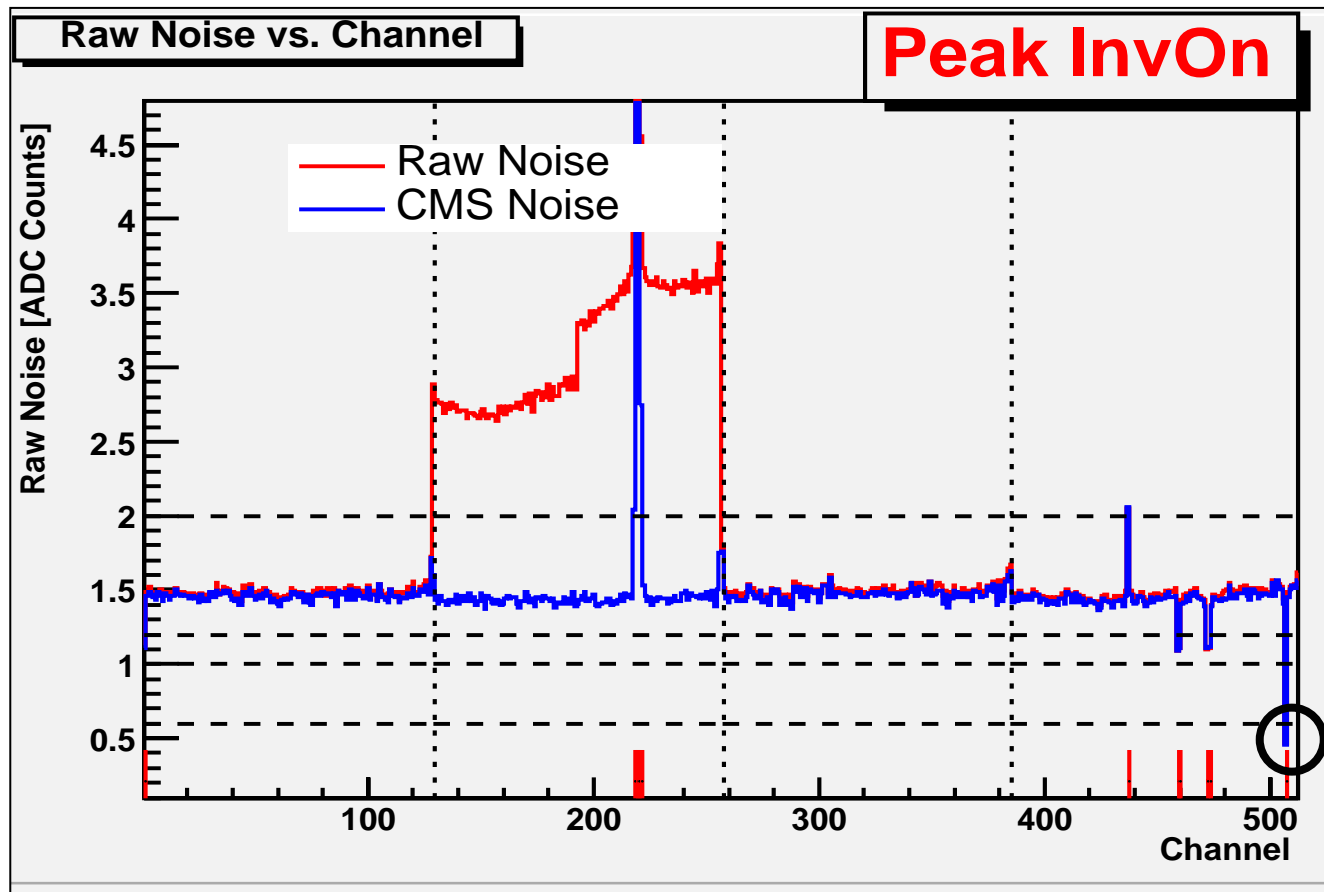


- After LT, one chip shows CMN





Module Time Degradation-705 II



After sitting on shelf for more than 3 months, module re-tested. A new pinhole is found



Conclusions

- The last few months has been a period of extreme growth in the US
 - Rod burn-in stands under commissioning at both FNAL and UCSB (see P. Tipton's talk)
 - Both sites have commissioned Vienna cold boxes with all 10 slots operational
- At UCSB, ability to test at peak production rate of 15/day demonstrated for 2 week period
 - Modules have excellent quality BUT CMN modules are still being produced at the ~5% rate!!!!
 - Same as rate seen before in modules using good re-probed sensors
- At FNAL, 2 of the 5 CMN modules still available are showing an increasing number of problems
 - More CMN chips and pinholes
 - CMN turn-on occurs near depletion voltage
 - Same as UCSB